SPAR - BRAMPTON (SSS)

9445 AIRPORT RD

### Critical Items List

SRMS

CIL Ref#: 2661

Revision: 0

FMEA Rev: 1

BRAMPTON ONTARIO L6\$4J3

System: SRMS

Subsystem: ELECTRICAL SUB-SYSTEM

Assembly Desc: Servo Power Amplifier

Part Number(s): 51140F1177-3

51140F1177-5

Item:

Function: Analog Interface Assembly

Provides Tachometer excitation, SCU signal filtering, Phase Locked Loop and tachometer counter circuits to provide measured motor speed data to inner and outer rate loops. Provides analog to digital conversion of MDA buck output voltage,

EPC +5V and reference voltages for BITE.

Failure Mode: Corrupt A/D Data.

H/W Func. Screen Failures

Criticality:

2 1R

Mission Phase: Orbit

Cause(s): Analog Interface Assembly

A/D converter BITE failure.

Incorrect channel selection or erroneous A/D converter data.

Loss of A/D converter resolution.

Failure effect on unit/end item:

Corrupt A/D conversion of MDA output voltage and reference voltages. A/D BITE will detect references voltages out of tolerance or erroneous

A/D conversion of MDA output will cause MDA demand voltage BITE or motor drive fault detection feedback voltage test to fail.

Worst Case: Loss of mission. Loss of primary modes.

Redundant Paths: Direct Drive (If Available).

Backup Drive.

### Retention Rationale

#### Design:

Discrete semiconductor devices are specified to at least the TX level of MIL-S-19500. Samples of all procured lots/date codes are subjected to destructive physical analysis (DPA) to verify the integrity of the manufacturing processes. Particle Impact Noise Detection (PIND) screening is performed on microcircuits, transistor and diodes that are mounted in a package with an internal cavity construction. The purpose of the test is to detect loose particles in the package, usually resulting from the assembly process. Device stress levels are derated in accordance with SPAR-RMS-PA.003 and verified by design review.

Resistors and capacitors used in the design are selected from established reliability (ER) types. Life expectancy is increased by ensuring that all allowable stress lovels are derated in accompance with SDAD DARS DARGE All accompanies and allowable stress lovels are derated in accompanies and allowable stress and allowable stress and allowable stress are derated in accompanies and allowable stress and allowable stress are derated in accompanies and allowable stress are derated at the stress are detailed at the stress are derated at the stress are derated at the stress are derated at the stress are detailed at the stress are detailed

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The A to D converter is screened to the requirements of SPAR-RMS-PA,003.

The SPA board is fabricated using Surface Mount Technology (SMT). This is a PWB assembly technology in which the components are soldered to the solder pads on the surface of the PWB. The significant advantage of this technology is to enable the parts on the board to be more densely packed, to reduce to overall volume and weight of the assembly.

The assembly process is highly automated. The parts are mounted on the boards using a computer controlled "pick and place" machine. The subsequent soldering operation is performed using a belt furnace, in which the time and temperature thermal profile that the PWB assembly is exposed to is tightly controlled and optimized to ensure proper part soldering attachment. The assembly is manufactured under documented procedures and quality controls. These controls are exercised throughout the assembly, inspection and testing of the unit. This inspection includes workmanship, component mounting, soldering, and conformal coating to ensure that it is in accordance with the NHB 5300 standards.

The SMT line used for the SPA PWB assembly has undergone a full qualification program, and assemblies produced on this line are used in other space programs.

The circuit board design has been reviewed to ensure adequate conductor width and separation and to confirm appropriate dimensions of solder pads and of component hold provisions. Parts mounting methods are controlled in accordance with MSFC-STD-154A, MSFC-STD-136 and SASD 2573751. These documents require approved mounting methods, stress relief and component security.

### Test:

QUALIFICATION TESTS - The SPA is subjected to the following qualification testing:

VIBRATION: Each axis of the QM is subjected to Flight Acceptance Vibration Test (FAVT), Qualification Acceptance Vibration Test (QAVT), and Qualification Vibration Tests (QVT) in accordance with the SPA Vibration Test Procedure (826586). The level and duration for FAVT is as per Figure 6 and Table 2 of 826586; the level and duration for QAVT is as per Figure 8 and Table of 826586. At the end of the three successive random vibration test in each axis, both directions (+/-) of each of the axis is subjected to a shock pulse test as per Figure 9 of 826586.

THERMALVACUUM: QM TVAC Test is in accordance with Figure 5 of the SPA TVAC Test Procedure (826588), with full Functional/Parametric Test performed at levels of +60 degrees C and -36 degrees C, and non-operating at -54 degrees C. The Qualification vacuum levels during TVAC is 1X10\*\*-6 torr or less. The total test duration is 7 1/2 cycles. The QM SPA is subjected to a minimum of 1000 hours of life testing and 1000 power On-Off cycles.

EMC: The QM is subjected to EMC Testing (tests CE01/CE03, CE07, CS01, CS02, CS06, RE02, RS02, and RS03) in accordance with the SPA EMC test Procedure (826477) based on MIL-STD-461A.

UNIT FLIGHT ACCEPTANCE TESTS - The FM SPA is subjected to the following acceptance testing:

VIBRATION: FM Acceptance Vibration Test (AVT) in accordance with the SPA Vibration Test Procedure (826586), with level and duration per Figure 6 and Table 2 of 826586.

THERMAL/VACUUM: FM TVAC Test is in accordance with Figure 6 of the SPA TVAC Test Procedure (826588), with levels of +49 degrees of and -25 degrees C for a duration of 1 1/2 cycles. The vacuum levels during Acceptance TVAC Test is 1X10\*\*-5 torr or less.

JOINT SRU TESTS - The SPA is tested as part of the joints (ambient and vibration tests only). The ambient ATP for the Shoulder Joint, Elbow Joint, and Wrist Joint are as per ATP.2001, ATP.2003, and ATP.2005 respectively. The vibration test for the Shoulder Joint, and Elbow or Wrist Joint are as per ATP.2004, ATP.2004 and ATP.2006 respectively. Through wire function, continuity and electircal isolation tests are performed per TP.283.

MECHANICAL ARM REASSEMBLY - The SPA's/Joints undergo a mechanical arm integration stage where electrical checks are performed per TP.2007.

MECHANICAL ARM TESTING - The outgoing split-arm is configured on the Strongback and the Manipulator Arm Checkout is performed per ATP.1932.

FLIGHT CHECKOUT: PDRS OPS Checkout (all vehicles) JSC 16987.

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checks for correct board installation, alignment of boards, proper connector contact mating, wire routing, strapping of wires etc. Post P.C. Board installation inspection includes cleanliness and workmanship (Spar/government rep. mandatory inspection point).

Unit Pre-Acceptance Test inspection, which includes an audit of lower tier inspection completion, as built configuration verification to as design etc (mandatory inspection point). A unit Test Readiness Review (TRR) which includes verification of test personnel, test documents, test equipment calibration/validation status and hardware configuration is convened by QA in conjunction with Engineering, Reliability, Configuration Control, Supplier as applicable, and the government representative, prior to the start of any formal testing (Acceptance or Qualification). Unit level Acceptance Testing (ATP) includes ambient performance, thermal and vibration testing (Spar/government rep.

Integration of unit to Joint SRU - Inspections include grounding checks, connectors for bent or pushback contacts, visual, cleanliness, interconnect wiring and power up test to the appropriate Joint Inspection Test Procedure (ITP). Joint level Pre-Acceptance Test Inspection, includes an audit of lower tier inspection completion, as built configuration verification to as design etc. Joint level Acceptance Testing (ATP) includes ambient and vibration testing (Spar/government rep. mandatory inspection point).

Mechanical Arm Reassembly - the integration of mechanical arm subassemblies to form the assembled arm. Inspections are performed at each phase of integration which includes electrical checks, through wiring checks, wiring routing, interface connectors for bent or pushback contacts etc. Mechanical Arm Testing - Strongback and flat floor ambient performance test (Spar/government rep. mandatory inspection point).

OMRSD Offline: Power-up arm. Verify no BITE errors.

OMRSD Online None.

Installation:

OMRSD Online Power-up arm. Verify no BITE errors.

Turnaround:

Screen Failure: A: Pass

B: Pass

C: Pass

Crew Training: The crew will be trained to always observe whether the arm is responding properly to commands. If it isn't, apply brakes,

Crew Action: Select Direct Drive if available. If D/D not available select Back-up Drive. Single/Direct Drive switch should be pulsed to maintain proper rates.

computer supported modes and D/D are lost. Autobrakes due to false BITE, Back-up Drive is available, BITE Override exists to regain computer supported modes. Direct Drive can be regained by cycling power.

Mission None.

Constraints:

Approvals:					
Functional Group	Name	Position	Telephone	Date Signed	Status
Engineer	Hiltz, Michael	Systems Engineer	4634	15Oct97	Signed
Reliability	Molgaard, Lena	Reliability Engineer	4590	15Oct97	Signed
Program Management Offic	Taplin, Ron	Technical Manager	4766	15Oct97	Signed
Subsystem Manager	Glenn, George	RMS Subsystem Manager	(281) 483-1516	24Mar98	Signed
Technical Manager	Peck, John	Technical Manager (JSC)	713-483-1264	31Mar98	Signed
FETY + MISSIAN ASSURANCE COAN, DAVID		RMS SOMA ENGINEER	(20)483-3479	29 81898	Duil.